

Ministry of Electronics & IT



India announces 2nd tranche of 17 approvals under Electronics Component Manufacturing Scheme (ECMS) - ₹ 7,172 crore investment, ₹ 65,111 crore production & 11,808 direct jobs

ECMS to Drive Next Phase of Value Chain Integration and Steer India's Electronics Manufacturing to \$500 Billion by 2030–31: Shri Ashwini Vaishnaw

Approved Units Sanctioned Across Nine States, Reinforcing Government's Push for Balanced Regional Growth and High-Skill Job Creation Beyond Metros

India Unveils ARKA-GKT1, its First Generation Energy-Efficient Edge Silicon Chip, Showcasing High-Performance Semiconductor Innovation

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In continuation of approval of seven applications for ₹ 5,532 crore announced earlier, the Ministry of Electronics and Information Technology has approved **17 more proposals** under the Electronics Components Manufacturing Scheme (ECMS). These approved projects span across the country with a total investment of **Rs 7,172 crore**, cumulative projected production of **Rs 65,111 crore**, and creation of **11,808 direct employment opportunities**.

17 projects worth ₹7,172 crore, across 9 States & UTs - approved under the Electronics Component Manufacturing Scheme.

 Focus areas:

1. Developing strong design teams.
2. Achieving Six Sigma quality for all 'Made in Bharat' products.
3. Promoting Swadeshi -... pic.twitter.com/iLgZPGBn6y

— Ashwini Vaishnaw (@AshwiniVaishnaw) November 17, 2025

The approved units are spread across **9 states**—Goa, Gujarat, Jammu & Kashmir, Karnataka, Madhya Pradesh, Maharashtra, Tamil Nadu, Uttar Pradesh, and Andhra Pradesh, reinforcing the government’s commitment to **balanced regional growth** and creation of high-skill jobs beyond metropolitan clusters.

The 2nd tranche includes a wide range of components and sub-assemblies, such as:

India’s first-ever **Optical Transceiver (SFP)** manufacturing facilities by *Jabil Circuit India Private Limited* and *Zetchem Supply Chain Services Private Limited*;

Oscillators for precise timing applications in communication devices, computers, and industrial electronics by *Rakon India Private Limited*; high-end precision

Enclosures for laptops and smartwatches by *Aequs Consumer Products Private Limited*;

Camera Modules by *ASUX Safety Components India Private Limited*, *Uno Minda Limited*, and *Syrma Mobility Private Limited*;

Connectors for electronic applications by *TE Connectivity India Private Limited*;

Multi-Layer PCBs by nine companies - *Hi-Q Electronics Private Limited*, *Secure Circuits Limited*, *Zetfab India Private Limited*, *Ehooome IOT Private Limited*, *Sierra Circuits (India) Private Limited*, *Meena Electrotech Private Limited*, *AT & S India Private Limited*, *Micropack Private Limited*, and *Infopower Technologies Private Limited*.

These components serve key sectors including smartphones, IT hardware, wearables, telecom, EVs, industrial electronics, defence, medical electronics, and renewable energy.

Minister of Electronics and IT Shri Ashwini Vaishnaw highlighted that ECMS is unlocking the next phase of **value chain integration**, from devices to components and sub-assemblies, ensuring India’s electronics sector reaches **\$500 billion** in manufacturing value by 2030–31.

Approved applicants expressed strong appreciation for the Government’s decisive support under ECMS, noting that MeitY’s proactive engagement, transparent processes, and fast-track approvals have been instrumental in advancing their projects. Industry leaders affirmed that the Ministry’s responsive, solution-oriented approach has boosted industry confidence and strengthened India’s position as a **trusted global manufacturing hub**.

The Minister also launched the 1st **Generation Energy-Efficient Edge Silicon Chip (SoC) (ARKA-GKT1)**, jointly developed by Cyient semiconductors Pvt Ltd and Azimuth AI. The Platform-on-a-Chip SoC integrates advanced computing cores, hardware accelerators, power-efficient design, and secure sensing into a single chip, delivering up to **10x better performance** while reducing cost and complexity. It supports smart utilities, cities, batteries, and industrial IoT, showcasing India’s shift toward a **product-driven, high-performance semiconductor ecosystem**.

Further, Hon’ble Minister of State for Electronics and IT emphasized that “ECMS demonstrates India’s readiness to compete with global manufacturing powerhouses and showcases the country’s commitment to creating resilient and trusted supply chains.”

The announcements were made during an event titled - **Electronics Component Manufacturing Scheme “The Foundation for a Globally Competitive Electronics Value Chain”**, organized by India Cellular & Electronics Association (ICEA).

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